## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 Assignment ID: PATI448874

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
United Microelectronics Corporation	08/12/2024

### **RECEIVING PARTY DATA**

Company Name:	Marlin Semiconductor Limited		
Street Address:	Plaza 255 Suite 2A		
Internal Address:	Blanchardstown Corporate Park 2		
City:	Dublin		
State/Country:	IRELAND		
Postal Code:	D15 YH6H		

### **PROPERTY NUMBERS Total: 3**

Property Type	Number
Patent Number:	7193483
Patent Number:	7705666
Patent Number:	8461890

### **CORRESPONDENCE DATA**

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 1(613)689-9983

**Email:** docketing@longitudelicensing.ie

Correspondent Name: Ronan O'Byrne
Address Line 1: Plaza 255 Suite 2A

Address Line 2: Blanchardstown Corporate Park 2
Address Line 4: Dublin, IRELAND D15 YH6H

ATTORNEY DOCKET NUMBER:	MSL - Bolt on #2
NAME OF SUBMITTER:	Ronan O'Byrne
SIGNATURE:	Ronan O'Byrne
DATE SIGNED:	08/23/2024

#### **Total Attachments: 6**

source=2024-08-12 - UMC to MSL Assignment - Bolt on #2#page1.tiff source=2024-08-12 - UMC to MSL Assignment - Bolt on #2#page2.tiff

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#### **EXHIBIT A**

#### FORM OF ASSIGNMENT

#### ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, United Microelectronics Corporation, a Taiwanese corporation, ("Assignor"), having a place of business at No. 3, Li-Hsin 2nd Road, Hsinchu Science Park, Hsinchu, Taiwan, R.O.C., hereby irrevocably assigns, sells, transfers, and conveys to Marlin Semiconductor Limited., a company organized and existing under the laws of Ireland ("Assignee"), having a place of business at Plaza 255 Suite 2A, Blanchardstown Corporate Park 2, Dublin D15 YH6H, Ireland, all rights, title and interest that exist as of June 28, 2024 and may exist in the future in and to any of the following (collectively, the "Patent Rights"):

- (a) the patent applications and patents listed in the attached Appendix I (collectively, the "Assigned Assets"), including all rights of priority;
- (b) all patents, divisionals, continuations, continuations-in-part, continued prosecution applications, provisional applications, requests for continuing examinations, reissues, reexaminations and extensions thereof and all pending applications therefor, and any other patent or patent application related to such patent or patent application by claim of direct or indirect priority or terminal disclaimer, and all pending applications therefor, and any patents resulting therefrom for all Assigned Assets in (a) above;
- (c) all foreign patents, foreign patent applications, and foreign counterparts relating to any item in any of the foregoing categories by claim of direct or indirect priority or terminal disclaimer (a) and (b), including, without limitation, certificates of invention, utility models, industrial design protection, design patent protection, and other governmental grants or issuances;
- (d) all items in any of the foregoing categories (a) through (c), whether or not claims in any of the foregoing have been rejected, withdrawn, cancelled, or the like;
- (e) all rights to apply in any or all countries of the world for patents, certificates of invention, utility models, industrial design protections, design patent protections, or other governmental grants or issuances of any type related to any item in any of the foregoing categories (a) through (d), including, without limitation, under the Paris Convention for the Protection of Industrial Property, the International Patent Cooperation Treaty, or any other convention, treaty, agreement, or understanding;
- (f) all claims and causes of action (whether known or unknown or whether currently pending, filed, or otherwise) for damages, injunctive relief, and any other remedies of any kind, accounting and information, and other secondary claims arising out of the past, current, and future infringement of the Assigned Assets and/or any item in any of the foregoing categories (b) through (e) by third parties which have accrued with Assignor or to which Assignor otherwise holds title; and

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all rights to collect royalties and other payments under or on account of any of the Assigned Assets and/or any item in any of the foregoing categories (b) through (f).

Assignor also hereby authorizes the respective patent office or governmental agency in each jurisdiction to issue any and all patents, certificates of invention, utility models or other governmental grants or issuances which may be granted upon any of the Assigned Assets in the name of Assignee, as the assignee to the entire interest therein.

Assignor will, at the reasonable request of Assignee, do all things necessary, proper, or advisable, including without limitation, the execution, acknowledgment, and recordation of specific assignments, oaths, declarations, and other documents on a country-by-country basis, to assist Assignee in obtaining, perfecting, sustaining, and/or enforcing the Patent Rights.

The terms and conditions of this assignment will inure to the benefit of Assignee, its successors, assigns, and other legal representatives and will be binding upon Assignor, its successors, assigns, and other legal representatives.

IN WITNESS WHEREOF, Assignor has caused its duly authorized representative to execute this assignment.

United Microelectronics Corporation

By:

Name: Olivia Liao Title: VP & GC

Date: August 12, 2024



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# ATTESTATION OF SIGNATURE PURSUANT TO 28 U.S.C. § 1746

The undersigned witnessed the signature of Olivia Liao to the above
ASSIGNMENT on behalf of United Microelectronics Corporation and makes the following
statements:
1. I am over the age of 18 and competent to testify as to the facts in this Attestation if called
upon to do so.
2. Olivia Liao is personally known to me (or proved to me on the basis of satisfactory evidence) and appeared before me on August 12 , 2024 to execute the above assignment document on behalf of United Microelectronics Corporation.
3. Olivia Liao executed the above assignment on behalf of United Microelectronics Corporation.
I declare under penalty of perjury under the laws of the United States of America that the statements made above in this Attestation are true and correct.
EXECUTED on August 12, 2024
Signature:

ONFIL SCLO

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Assignee hereby declares the acceptance of the assignment of Patent Rights.

ASSIGNEE:

Marlin Semiconductor Limited

By:

Name: Paul Ahern

Title: Director

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## APPENDIX I

# PATENTS

Publication Number	Country	Application Number	File Date	Publication Date
US7193483	US	US11/089,310	3/24/2005	3/20/2007
US7705666	US	US12/365,874	2/4/2009	4/27/2010
TWI441450	TW	TW098103485	2/4/2009	6/11/2014
CN101807912B	CN	CN200910006377.7	2/16/2009	4/3/2013
US8461890	US	US13/186,557	7/20/2011	6/11/2013
TWI535216	TW	TW100125698	7/20/2011	5/21/2016

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**RECORDED: 08/23/2024**